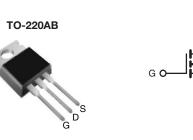


**Vishay Siliconix** 

### Power MOSFET

PRODUCT SUMMA	RY				
V <sub>DS</sub> (V)	400				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.55			
Q <sub>g</sub> (Max.) (nC)	6	3			
Q <sub>gs</sub> (nC)	9.0				
Q <sub>gd</sub> (nC)	3	2			
Configuration	Sin	igle			



S N-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF740PbF
Lead (FD)-hee	SiHF740-E3
SnPb	IRF740
SHED	SiHF740

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	400	- V	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	V at 10 V	T <sub>C</sub> = 25 °C		10		
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_C = 100 \ ^\circ C$	ID	6.3	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	40		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	520	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	10	A	
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	13	mJ		
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$		PD	125	W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)         for 10 s         300 <sup>d</sup>		300 <sup>d</sup>				
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque			Ē	1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 9.1 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 10$  A (see fig. 12).

c.  $I_{SD} \leq 10$  A, dl/dt  $\leq 120$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50 -			°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		1.0		-		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$			400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		1	0.49	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	/ <sub>GS</sub> , I <sub>D</sub> = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	Vo	<sub>GS</sub> = ± 20 \	/	-	-	± 100	nA
Zero Gate Voltage Drain Current	laaa	$V_{DS} = 4$	100 V, V <sub>GS</sub>	= 0 V	1	-	25	
Zero Gale Voltage Drain Gurrent	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V, <sup>1</sup>	320 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C		-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub>	= 6.0 A <sup>b</sup>	-	-	0.55	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 50 \text{ V}, I_D = 6.0 \text{ A}^{b}$		5.8	-	-	S	
Dynamic		_				_	_	
Input Capacitance	C <sub>iss</sub>	١	$I_{\rm GS} = 0  {\rm V},$		-	1400	-	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25 V,		-	330	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	120	-		
Total Gate Charge	Qg				-	-	63	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	5	A, $V_{DS} = 320 V$ ,	-	-	9.0	nC
Gate-Drain Charge	Q <sub>gd</sub>		see n	g. 6 and 13 <sup>b</sup>	-	-	32	
Turn-On Delay Time	t <sub>d(on)</sub>		1		-	14	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 200 \text{ V}, \text{ I}_D = 10 \text{ A}$ $R_g = 9.1 \ \Omega, \ R_D = 20 \ \Omega, \text{ see fig. } 10^b$		-	27	-	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	50	-		
Fall Time	t <sub>f</sub>			-	24	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-		
Drain-Source Body Diode Characteristic	s	·						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol		-	-	10		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	<ul> <li>showing the integral reverse</li> <li>p - n junction die</li> </ul>	ode	G	-	-	40	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C,	I <sub>S</sub> = 10 A, '	V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>				-	370	790	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> =	10 A, dl/c	ιτ = 100 Α/μs <sup>o</sup>	-	3.8	8.2	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	-on time is	negligible (turn	-on is do	minated h	v Ls and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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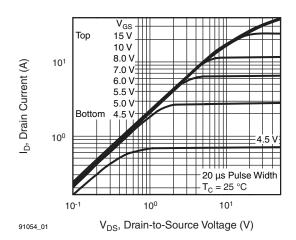


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

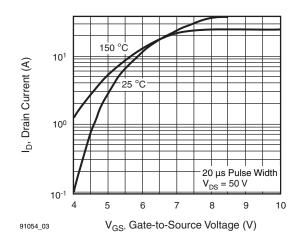


Fig. 3 - Typical Transfer Characteristics

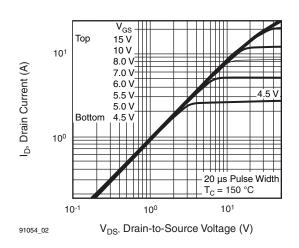


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \ ^{\circ}C$ 

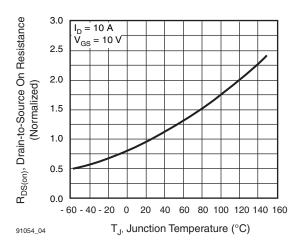


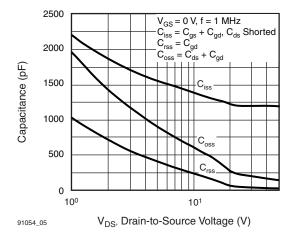
Fig. 4 - Normalized On-Resistance vs. Temperature

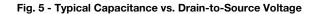
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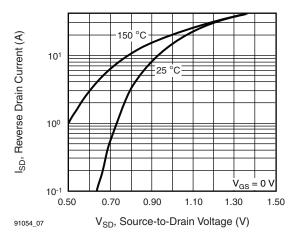
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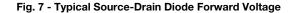
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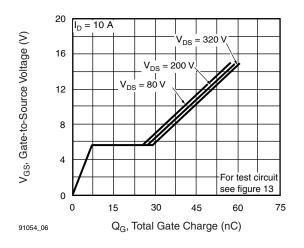


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

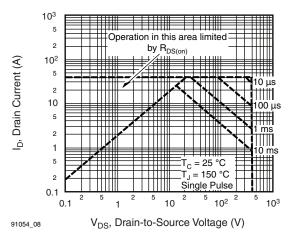


Fig. 8 - Maximum Safe Operating Area

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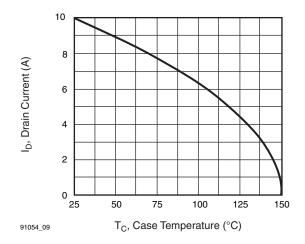


Fig. 9 - Maximum Drain Current vs. Case Temperature

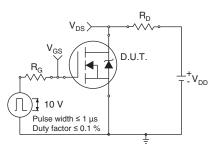


Fig. 10a - Switching Time Test Circuit

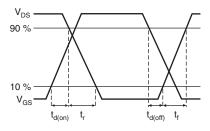


Fig. 10b - Switching Time Waveforms

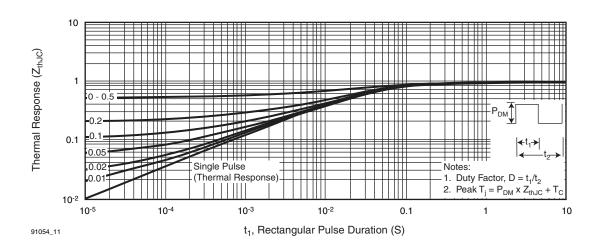


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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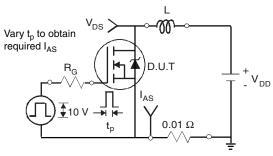


Fig. 12a - Unclamped Inductive Test Circuit

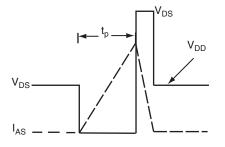
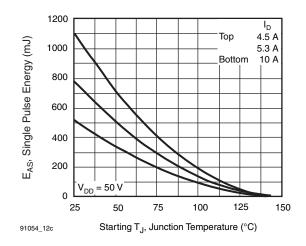
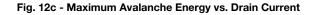
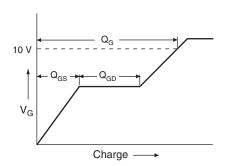


Fig. 12b - Unclamped Inductive Waveforms









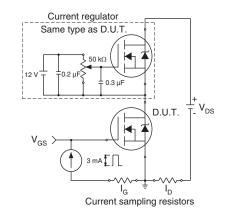
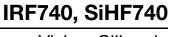


Fig. 13b - Gate Charge Test Circuit

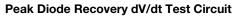
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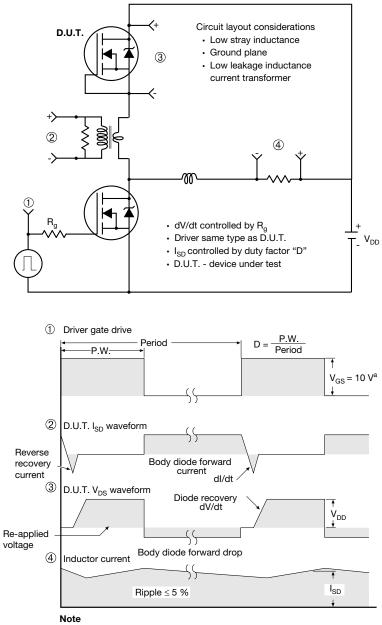
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a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

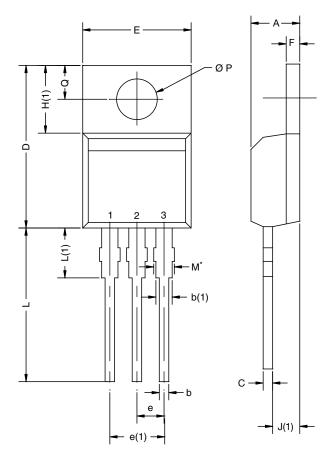
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## **TO-220AB**

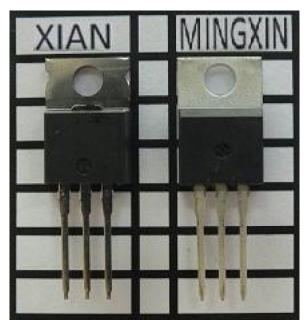


	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

#### Notes

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

Xi'an and Mingxin actual photo





Vishay

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